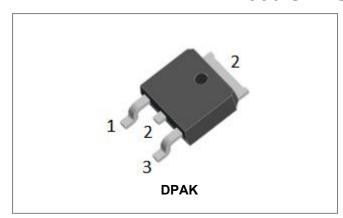






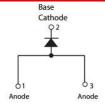
MBRD330 SCHOTTKY RECTIFIER



Features

- 150°C T_J operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- "-A" is an AEC-Q101 qualified device
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Disk drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

Maximum Ratings:

| Characteristics | Symbol | Condition | Max. | Units |
|--|--|---|------|-------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | - | 30 | V |
| Average Rectified Forward Current | I _{F (AV)} | 50% duty cycle @Tc=125°C, rectangular wave form | 3 | Α |
| Peak One Cycle Non-Repetitive Surge Current | I _{FSM} | 8.3ms, Half Sine pulse | 75 | Α |

Electrical Characteristics:

| Characteristics | Symbol | Condition | Тур. | Max. | Units |
|-----------------------|-----------------|--|-----------|---------------|-------|
| Forward Voltage Drop* | V _{F1} | @ 3A, Pulse, T _J = 25 °C @ 6A, Pulse, T _J = 25 °C | 0.45 - | 0.60 0.70 | V |
| | V _{F2} | @ 3A, Pulse, T _J = 125 °C @ 6A, Pulse, T _J = 125 °C | 0.35 | 0.45 0.625 | V |
| Reverse Current * | I _{R1} | $@V_R = \text{rated } V_{R}, T_J = 25 ^{\circ}\text{C}$ | 0.02 | 0.2 | mA |
| | I _{R2} | @V _R = rated V _R , T _J = 125 °C | 18 | 50 | mA |
| Junction Capacitance | Ст | @ $V_R = 5.0V$, $T_C = 25$ °C $f_{SIG} = 1$ MHz | 200 | 300 | pF |

^{*} Pulse width < 300 μ s, duty cycle < 2%





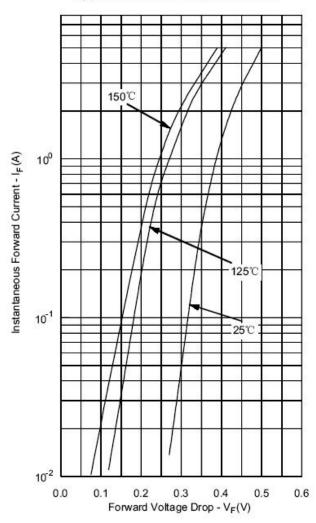


Thermal-Mechanical Specifications:

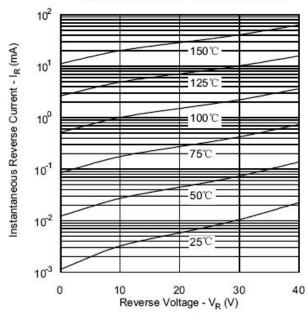
| Characteristics | Symbol | Condition | Specification | Units |
|---|-------------------|-----------|---------------|-------|
| Junction Temperature | TJ | - | -55 to +150 | °C |
| Storage Temperature | T _{stg} | - | -55 to +150 | °C |
| Typical Thermal Resistance Junction to Case | R ₀ JC | - | 6 | °C/W |
| Approximate Weight | wt | - | 0.39 | g |
| Case Style | DPAK | | | |

Ratings and Characteristics Curves

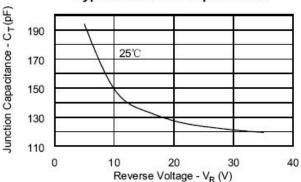
Typical Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance



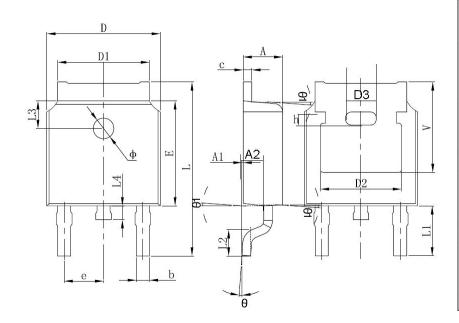
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Mechanical Dimensions DPAK



| SYMBOL | Millimeters | | Inches | | |
|--------|-------------|-------|------------|-------|--|
| | Min. | Max. | Min. | Max. | |
| А | 2.20 | 2.40 | 0.087 | 0.094 | |
| A1 | 0.00 | 0.127 | 0.000 | 0.005 | |
| b | 0.66 | 0.86 | 0.026 | 0.034 | |
| С | 0.46 | 0.60 | 0.018 | 0.024 | |
| D | 6.50 | 6.70 | 0.256 | 0.264 | |
| D1 | 5.13 | 5.46 | 0.202 | 0.215 | |
| D2 | 4.83 REF. | | 0.190 REF. | | |
| Е | 6.00 | 6.20 | 0.236 | 0.244 | |
| е | 2.186 | 2.386 | 0.086 | 0.094 | |
| L | 9.70 | 10.40 | 0.381 | 0.409 | |
| L1 | 2.90 REF. | | 0.144 REF. | | |
| L2 | 1.40 | 1.70 | 0.055 | 0.067 | |
| L3 | 1.60 REF. | | 0.063 REF. | | |
| L4 | 0.60 | 1.00 | 0.024 | 0.039 | |
| Ф | 1.10 | 1.30 | 0.043 | 0.051 | |
| Θ | 0° | 8° | 0° | 8° | |
| h | 0.00 | 0.30 | 0.000 | 0.012 | |
| V | 5.35 REF. | | 0.211 | REF. | |

Ordering Information

| Device | Package | Shipping |
|-----------|-------------------|----------------|
| MBRD330 | DPAK (Pb-Free) | 2500pcs / reel |
| MBRD330TR | DPAK (Pb-Free) | 2500pcs / reel |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

 MBRD330
 = Part Name

 SSG
 = SSG

 YY
 = Year

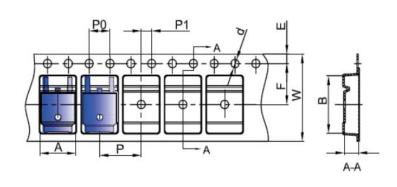
 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape & Reel Specification DPAK



| SYMBOL | Millimeters | | |
|--------|-------------|-------|--|
| | Min. | Max. | |
| Α | 6.80 | 7.00 | |
| В | 10.40 | 10.60 | |
| С | 2.60 | 2.80 | |
| d | Ф1.45 | Ф1.65 | |
| E | 1.65 | 1.85 | |
| F | 7.40 | 7.60 | |
| P0 | 3.90 | 4.10 | |
| Р | 7.90 | 8.10 | |
| P1 | 1.90 | 2.10 | |
| W | 15.90 | 16.30 | |

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